



香港聲學學會

Hong Kong Institute of Acoustics

Support to HKIOA members in participating INTER-NOISE 2014

The HKIOA encourages members to actively participate in international noise conferences and is prepared to financially support members who wish to join the coming INTER-NOISE 2014 from 16 – 19 November in Melbourne Convention and Exhibition Centre, Melbourne, Australia.

The Institute's Executive Committee has decided to sponsor a maximum of 5 papers at HK\$4,000 each.

The Institute welcomes members to apply for this support and here are the selection criteria for successful candidates:

1. The applicant must be a **Corporate Member** of HKIOA.
2. The applicant must submit and present a paper (See **Note** below).
3. The applicant must be an author (or a co-author in case of joint authorship) of the paper.
4. Only one author is eligible to be an applicant for each paper to be sponsored.
5. The applicant must agree to put an acknowledgement in the paper with the following statement: "*The presentation of this paper is sponsored by the Hong Kong Institute of Acoustics.*"
6. The applicant must send in his/her application by e-mail to admin@hkioa.org before **4 July 2014**.

In case there are more than 5 applicants, the selection will be made by a draw to be arranged by the HKIOA's Executive Committee. Results of the draw will be final and announced on or before **18 July 2014** to the successful candidates as well as on the Institute's webpage. The sponsored amount will be paid to the successful applicant after his/her attendance of the conference and upon presentation of (a) the relevant official receipt issued by the conference organizer, and (b) a copy of the accepted paper.

Note:

Notification of the paper's acceptance was sent to authors on 12 May 2014.

Manuscripts for publication in proceedings are due on 25 July 2014. Please visit this website for details, <http://www.acoustics.asn.au/divisions/VIC/internoise2014/>.

A handwritten signature in black ink, appearing to read 'Wilson Ho'.

Wilson Ho
Activities Sub-committee
HKIOA